

Date: <u>2005.08.01</u>

Specifications for Approval

Cus	tomer	<u>:</u>		
Mod	el name	: LMC	16213A-YTDSYW-B	REV: A
Des	cription	: LIQU	IID CRYSRAL DISP	LAY MODULE
	DES	SIGN	СНЕСК	APPROVED
	Customer Approval		Accept Reject Comment:	oved by:



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2. REVISION RECORD

LCM MODULE NUMBERING SYSTEM

PART NUMBER: LMAx.....yB-CDEFGHI-JK

L: LONDA TECHNOLOGY

M: MODULE

A: DISPLAY CONTENTS C--- CHARACTER TYPE

G--- GRAPHIC TYPE S---SEGMENT TYPE

x.....: CHARACTERS Vs. LINES FOR CM

COLUMNS Vs. ROWS FOR GM SERIALS NUMBER FOR SM

y: DISTRIBUTE ACCORDING TO SIZE

B: VERSION OF PCB

C: LCD TYPE:

Y---YELLOW STN G---GRAY STN B---BLUE STN

F---FSTN T---TN

D: POLARIZER TYPE:

R--- REFLECTIVE T--- TRANSFLECTIVE

M--- TRANSMISSIVE

E: VIEWING TEMPRETURE:

U--- 12:00 D--- 6:00 L--- 9:00 R--- 3:00

F: BACKLIGHT TYPE:

D---BOTTOM LED S---SIDE LED E--- EL C--- CCFL

N---NO BACKLIGHT

G: COLOR OF BACKLIGHT:

Y---YELLOW/GREEN G--- GREEN B--- BLUE

W--- WHITE O--- ORANGE A--- AMBER

H:OPERATING TEMPRETURE:

N--- NORMAL, W--- EXTENDED, X:ESPECIALLY EXTENDED

I: DENOTE DIFFERENT CHARACTER TABLE:

NORMAL ELLIPSIS, T--- TAB, G--- COG

-JK:

FOR CM:

J: IC TYPE: A--- KS0066U B--- SPLC780

K: CHARACTER STOREROOM SEQUENCE NUMBER

FOR GM:

J: BACKLIGHT DRIVER

Y--- WITH N--- WITHOUT

K: DC-DC CONVERTER

Y--- WITH N--- WITHOUT

1. FEATURES

The features of LCD are as follows

* Display mode : STN, Positive, Transflective

* Color : Display dot : Dark Black

Background: Yellow-Green

* Display Format : 16 X 2 Characters

* IC : Samsung KS0065 and KS0066

* Interface Input Data : 4-bit or 8-bit Parallel

* Driving Method : 1/16 Duty, 1/5 Bias

* Viewing Direction : 6 O'clock

* Backlight : LED (Yellow-Green)

2. MECHANICAL SPECIFICATIONS

Item	Specification	Unit
Module Size	53.0(W) x 20.0(H) X 8.0MAX(T)	mm
Viewing Area	36.0(W) X 10.0(H)	mm
Effective Display Area	34.10(W)X 7.40(H)	mm
Character Font	5 X 8 with Cursor	
Character Pitch	2.15(W) X 4.25(H)	mm
Character Size	1.85(W) X 3.15(H)	mm
Dot Pitch	0.33(W) X 0.35(H)	mm
Dot Size	0.38(W) X 0.40(H)	mm

3. ELECTRICAL SPECIFICATIONS

3-1. Absolute Maximum Ratings (Vss=0V)

Item	Symbol	Sta			
item	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage For Logic	VDD-Vss	-0	-	+7.1	V
Supply Voltage For LCD Drive	VDD-V0	-0	-	+10	V
Input Voltage	Vin	Vss	-	Vdd	V
Operating Temp.	Тор	-20	-	+70	°C
Storage Temp.	Tst	-30	-	+80	°C

Notes : Voltages VDD<u>></u>V1<u>></u>V2<u>></u>V3<u>></u>V4<u>></u>V5<u>></u>V0 must always be satisfied.

3. ELECTRICAL SPECIFICATIONS (Continued)

3-2. Electrical Characteristics (Vss=0V)

Item	1	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Logic Supply	/ Voltage	VDD – Vss	Ta=-20~70°C	4.5	5	5.5	\
LCD Drive Voltage (Recommended Voltage)		VDD - V0	Ta=25°C	3.9	4.5	4.9	V
	"H" Level	V _{IH}	V _{DD} =5V ± 5%	0.8	-	VDD	V
Input Voltage	"L" Level	V _{IL}	VDD-3V ± 3%	0	-	0.2	V
	"H" Level	V _{OH}	V _{DD} =5V ± 5%	0.8	-	VDD	V
Output Voltage	"L" Level	V _{OL}	VDD-3V ± 3%	0	-	0.2	V
Current Con	sumption	I _{DD}	$V_{DD} = 5V \pm 5\%$ $V_{DD} - V_0 = 4.5V$	-	1.34	3.0	mA

NOTE: 1) Duty Ratio=1/16, Bias Ratio=1/5

2) Measuring in Dots ON-state

3-3. BACKLIGHT

3-3-1. Absolute Maximum Ratings

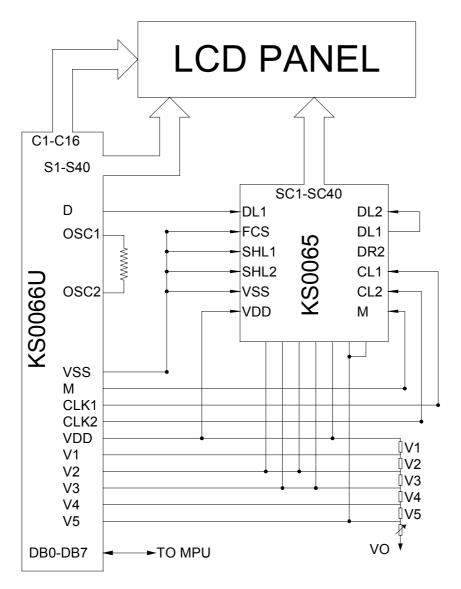
Item	Symbol	Condition	Min.	Тур.	Max	Unit
Forward Current	IF	- Ta= 25°ℂ	-	-	60	mA
Reverse Voltage	VR	1a- 25 C	-	-	5	V
Power Dissipation	PD	Ta= 25°℃	ı	ı	300	mW

3-3-2. Opto-electronic Characteristics

Item	Symbol	Condition	Min.	Тур.	Max	Unit
Forward Voltage	VF	Ta= 25°ℂ	-	5.0	5.5	V
Luminous	-	IF= 100mA	35	-	-	cd/m²

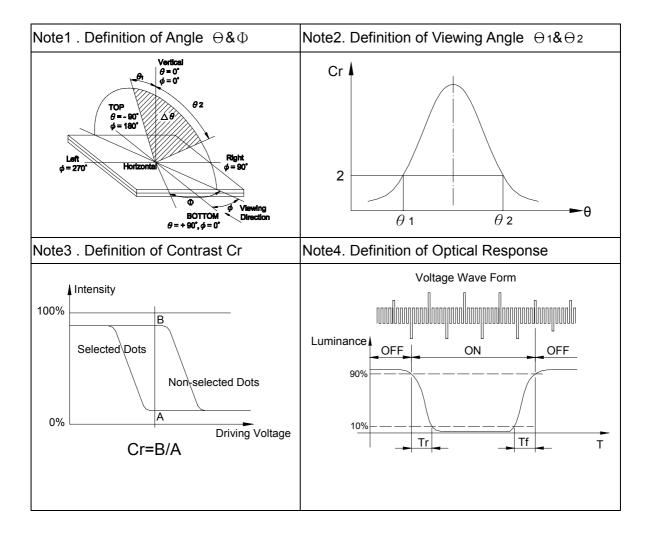
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4. BLOCK DIAGRAM AND POWER SUPPLY



5. ELECTRO - OPTICAL CHARACTERISTICS

Item	Symbol	Temp.	Min.	Тур.	Max.	Unit	Conditions	Note
Viewing	⊖2-⊖1	25℃	30	92	-	Dog		1.2
Angle	Φ	250	80	90	-	Deg.	-	1,2
Contrast Ratio	Cr	25℃	2	11.1	11.9	-	⊕=0° ⊖=0°	3
Response	Т.,	25 ℃	-	92	250		⊖=0°	4
Time(rise)	Tr	0℃	-	950	1150	ms	Ф =0 °	4
Response	Τf	25 ℃	-	119	250	ma	⊖=0°	4
Time(fall)	Tf	0℃	-	950	1150	ms	Ф =0°	4



6. TERMINAL PIN FUNCTION

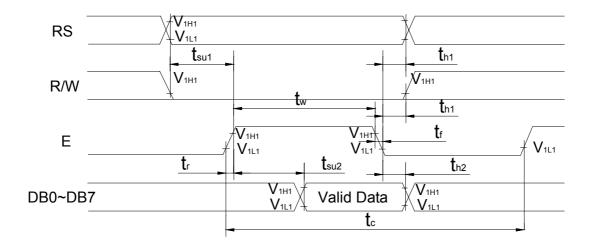
6-1. Interface Pin Function Description

Pin NO.	Symbol	1/0	Functions
1	Vss	Power	GND
2	Vdd	Power	Power supply for logic circuit
3	V0	Power	Contrast adjustment
4	RS	I	Register select signal
5	R/W	I	Used as read/write selection input when Rw="high" read operation Rw="Low", write operation
6	E	I	Enable signal
7	DB0		
8	DB1		
9	DB2		
10	DB3	I/O	Data bus
11	DB4	1/0	Data bus
12	DB5		
13	DB6		
14	DB7		
15	LED(+)	-	Backlight(+)
16	LED(-)	-	Backlight(-)

7.TIMING CHARACTERISTICS

7-1. Write Mode (Writing data from MPU to LCM)

Mode	Symbol	Min.	Тур.	Max.	Unit
E Cycle Time	tc	500		-	ns
E Rise / Fall Time	tr, tr	-	-	20	ns
E Pulse Width (High, Low)	tw	230	-	-	ns
R/W and RS Setup Time	t su1	40	-	-	ns
R/W and RS Hold Time	t _{H1}	10	-	-	ns
Data Setup Time	tsu2	80	-	-	ns
Data Hold Time	t _{H1}	10	-	-	ns

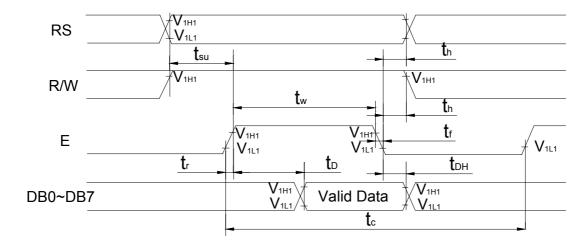


Write Mode Timing Diagram

7.TIMING CHARACTERISTICS (Continued)

7-2. Read Mode (Reading data from MPU to LCM)

Mode	Symbol	Min.	Тур.	Max.	Unit
E Cycle Time	tc	500	-	-	ns
E Rise / Fall Time	tr, tr	-	-	20	ns
E Pulse Width (High, Low)	tvv	230	-	-	ns
R/W and RS Setup Time	t su1	40	-	-	ns
R/W and RS Hold Time	t _{H1}	10	-	-	ns
Data Output Delay Time	tsu2		-	120	ns
Data Hold Time	t _{H1}	5	-	-	ns



Read Mode Timing Diagram

8.INSTRUCTION SET

8-1. Instruction Table

Function	RS	R/ W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description	Execu. Time*(Max.)		
Clear Display	0	0	0	0	0	0	0	0	0	1	Clear Entire Display	1.53mS		
Return Home	0	0	0	0	0 0 0 0 1 Return Display Being Shifted to Original Position						Shifted to Original	1.53mS		
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Set Cursor Move Direction And Specifies 39u Shift of Display			
Display ON/OFF Control	0	0	0	0	0 0 1 D C B C: Cursor On/Off B: Cursor Blink/Not						C: Cursor On/Off	39uS		
Cursor or Display shift	0	0	0	0	1 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1					*	Move Cursor And Shift Display 39uS			
Function Set	0	0	0	0	1 DL N F * * S				*	*	Set DL, N, F 39u			
Set CG RAM Address	0	0	0	1 ACG							Set CG RAM Address 39uS			
Set DD RAM Address	0	0	1		•		ADD)			Set DD RAM Address 39uS			
Read Busy Flag & Address	0	1	BF				AC				BF: Busy Flag Read AC Contents 0u			
Write Data to CG RAM	1	0		WRITE DATA							Write Data to DD RAM or CG RAM			
Read Data From CG/DD RAM	1	1			RE	AD	DA	λTΑ			Read Data From DD RAM or CG RAM	43uS		
Remark	S S/0 R/I DL N F	I/D = 1 : Increment 0 : Decrement S = 1 : Accompanies Display Shift S/C = 1 : Display Shift 0 : Cursor Move R/L = 1 : Shift right 0 : Shift left DL = 1 : 8 Bits 0 : 4 Bits N = 1 : 2 Lines 0 : 1 Line DD RAM : Display Data RAM CG RAM : Character Generator RAM ACG : CG RAM Address ADD : DD RAM Address Corresponds to Cursor Address								nerator RAM ess ress sor Address er used for				

NOTE: When an MPU program with checking the Busy Flag(DB7) is made, it must be necessary 1/2Fosc is necessary for executing the next instruction by the falling edge of the "E" signal after the Busy Flag(DB7) goes to "low".

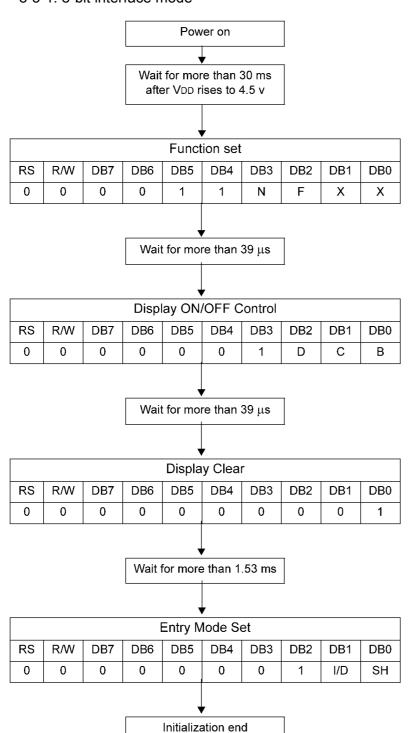
8-2. DDRAM Address

Display position	Column	1	2	 15	16
DD RAM Address (Hex-Decimal)	1-Line	00H	01H	 0EH	0FH
	2-Line	40H	41H	 4EH	4FH

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- 8-3. Instruction Initialization
- 8-3-1. 8-bit interface mode



N	0	1-line mode						
	1	2-line mode						
F	0	display off						
•	1	display on						
		-						

D	0	display off
	1	display on

C	0	cursor off						
•	1	cursor on						

В	0	blink off						
	1	blink on						

I/D	0	decrement mode
""	1	increment mode

SH	0	entire shift off					
011	1	entire shift on					

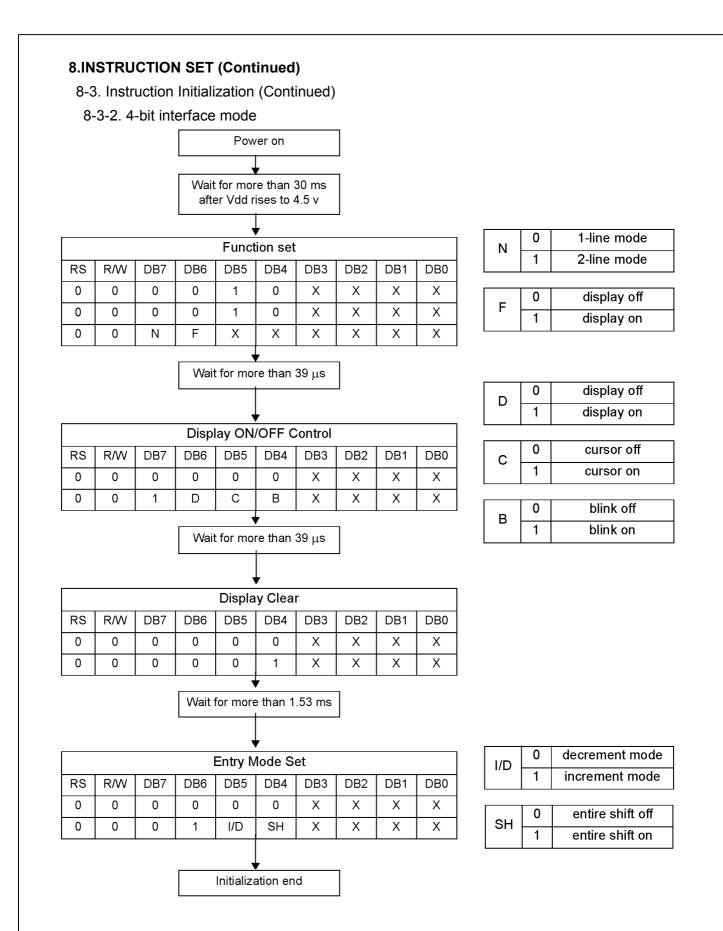
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PRODUCT SPECIFICATIONS

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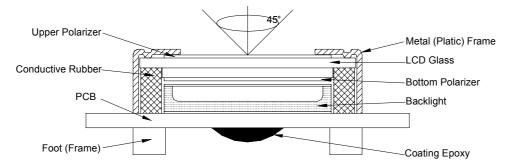
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9. FONT TABLE

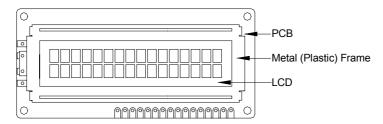
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	НІНН	HHLL	HHHL	нннн
LLLL															
LLLH															
LLHL															
LLHH															
LHLL															
LHLH															
LHHL															
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10. QUALITY SPECIFICATIONS

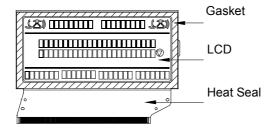
- 10 1. LCM Appearance and Electric inspection Condition
 - 1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.



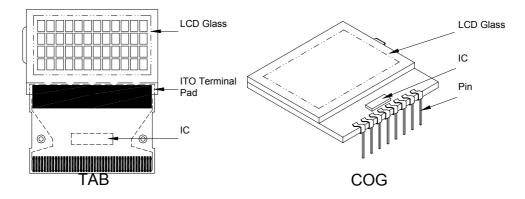
- 2. View Angle: with in 45° around perpendicular line.
- 10 2. Definition
 - 1. COB



2. Heat Seal



3. TAB and COG



10. QUALITY SPECIFICATIONS (Continued)

10-3. Sampling Plan and Acceptance

1. Sampling Plan

MIL - STD - 105E (\parallel) ordinary single inspection is used.

2. Acceptance

Major defect: AQL = 0.25%Minor defect: AQL = 0.65%

10-4. Criteria

1.COB

Defect	Inspection Item	Inspection Standards	
Major	PCB copper flakes peeling off	Any copper flake in viewing Area should be greater than 1.0mm ²	Reject
Major	Height of coating epoxy	Exceed the dimension of drawing	Reject
Major	Void or hole of coating epoxy	Expose bonding wire or IC	Reject
Major	PCB cutting defect	Exceed the dimension of drawing	Reject

2.SMT

Defect	Inspection Item	Inspection Standa	ards
Minor	Component marking not readable		Reject
Minor	Component height	Exceed the dimension Of drawing	Reject
Major	Component solder defect (missing, extra, wrong component or wrong orientation		Reject
Minor	Component position shift component soldering pad D Z A Y	X < 3/4Z Y > 1/3D	Reject Reject
Minor	Component tilt component soldering pad	Y > 1/3D	Reject
Minor	Insufficient solder component PAD	<i>θ</i> ≤ 20°	Reject

10. QUALITY SECIFICATIONS (Continued)

10-4. Criteria (Continued)

3. Metal (Plastic) Frame

Defect	Inspection Item	lı	nspection Standar	rds	
Major	Crack / breakage	Any	/where	Reject	
		W	L	Acceptable of Scratch	
		w<0.1mm	Any	Ignore	
		0.1 <u><</u> w<0.2mm	L <u><</u> 5.0mm	2	
Minor	Frame Scratch	0.2 <u><</u> w<0.3mm	L <u><</u> 3.0mm	1	
		w <u>></u> 0.3mm	Any	0	
		Note: 1. Above criteria applicable to scratch lines with distance greater than 5mm. 2. Scratch on the back side of frame (not visible) can be ignored.			
				Acceptable of Dents / Pricks	
		Φ<	1.0mm	2	
	Frame Dent , Prick	1.0< ₫	> <u><</u> 1.5mm	1	
Minor	$\Phi = \frac{L + W}{2}$	1.5r	mm<⊕	0	
	2	/ pricks with dis	criteria applicable tance greater than prick on the back signored	5mm	
Minor	Frame Deformation	Exceed the dimension of drawing			
Minor	Metal Frame Oxidation		Any rust		

4. Flexible Film Connector (FFC)

Defect	Inspection Item	Inspection Standards		
Minor	Tilted soldering	Within the angle +5°	Acceptable	
Minor	Uneven solder joint /bump		Reject	
Minor	Hole $\Phi = \frac{L + W}{2}$	Expose the conductive line	Reject	
IVIII IOI	1 noie Ψ- 2	Φ > 1.0mm	Reject	
Minor	Position shift	Y > 1/3D	Reject	
IVIII IOI		X > 1/2Z	Reject	

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10. QUALITY SPECIFICATIONS (Continued)

10-4. Criteria (Continued)

5. Screw

Defect	Inspection Item	Inspection Standards	
Major	Screw missing/loosen		Reject
Minor	Screw oxidation	Any rust	Reject
Minor	Screw deformation	Difficult to accept screw driver	Reject

6. Heatseal . TCP . FPC

Defect	Inspection Item	Inspection Standards	
Major	Scratch expose conductive layer		Reject
Minor	HS Hole $\Phi = \frac{L + W}{2}$	Ф> 0.5mm	Reject
Major	Adhesion strength	Less than the specification	Reject
Minor	Position shift	Y > 1/3D	Reject
IVIII IOI		X > 1/2Z	Reject
Major	Conductive line break		Reject

7. LED Backing Protective Film and Others

Defect	Inspection Item	Inspection Standards			
		Acceptable number of units			
		⊕ <u><</u> 0.10mm	Ignore		
		0.10<⊕ <u><</u> 0.15mm	2		
Minor	LED dirty, prick	0.15<⊕ <u><</u> 0.2mm	1		
		Φ>0.2mm	0		
		The distance between any two spots should be ≥5mm Any spot/dot/void outside of viewing area is acceptable			
Minor	Protective film tilt	Not fully cover LCD	Reject		
Major	COG coating	Not fully cover ITO circuit	Reject		

8. Electric Inspection

Defect	Inspection Item	Inspection Standards	
Major	Short		Reject
Major	Open		Reject

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10. QUALITY SPECIFICATIONS (Continued)

- 10-4. Criteria (Continued)
- 9. Inspection Specification of LCD

Defect	Insp	ect Item			Ins	pection	S	tandard	S	
		* Glass Scratch	W			0.03	0.0	0.0 <u><</u> W>0	5 V	V>0.05
				L<5			L<3		Any	
Minor	Linear Defect	* Polarizer Scratch * Fiber and Linear	ACC. NO.			1		1		Reject
		material	Note	L is th	e ler	ngth and V	V is th	e width of	the de	efect
		* Foreign material	Φ	Φ<	0.1	0.1<⊕ <u><</u> 0).15 ().15<⊕ <u><</u> 0	.2	⊕>0.2
	Black Spot and	between glass and polarizer or glass	ACC. NO.	3E/ 100r	A / nm²	2		1		0
Minor	Polarizer Pricked	and glass * Polarizer hole or protuberance by external force	Note	Φ is	the a			er of the de ects > 10r		
		* Unobvious	Φ		Φ <u><</u>	0.3	0.3	<⊕ <u><</u> 0.5	0.	5 <⊕
	White Spot	transparant foreign material between	ACC. NO.	3E/	4/10	00mm ²		1		0
Minor	and Bubble in polarizer	glass and glass or glass and polarizer * Air protuberance between polarizer and glass	Note Φ is the average d		petween tv	vo def				
			Φ	Φ <u><</u> 0	.10	0.10<⊕ <u><</u> 0.20		0.20<⊕ <u><</u> 0.25		⊕>0.25
		W-1 1	ACC. NO.	3E <i>A</i> 100m	A/ nm²	2		1		0
Minor	Segment Defect	, w		W is r	nore	than 1/2	segme	ent width		Reject
	Beleat		Note	$\Phi = \frac{L + W}{2}$ Distance between two defect is 10mm						
			Φ	Φ <u><</u> 0	.10	0.10<⊕≤	<u><</u> 0.20	0.20<⊕	<u><</u> 0.25	⊕>0.25
Minor	Protuberant Segment	W	W	Glu		W <u><</u> 1/2 W <u><</u> 0		W <u><</u> 1/2 W <u><</u> 0		Ignore
		Φ = (L + W) / 2	ACC. NO.	3E <i>A</i> 100n	\ nm²	2		1		0
			1. Seg	ment						
			E	3	B <u><</u>	0.4mm	0.4 <e< td=""><td>3<u><</u>1.0mm</td><td>B>′</td><td>1.0mm</td></e<>	3 <u><</u> 1.0mm	B>′	1.0mm
	Assembly		B-	A	B-	A<1/2B	В-	A<0.2	B-A	<0.25
Minor	Mis-alignment	B A	Jud	dge Acceptable		Acc	eptable	Acc	eptable	
			2. Dot	Matrix						
			Defo	ormatio	on>2	0				Reject
Minor	Stain on LCD Panel Surface		Accept when stains can be wiped lightly with a soft cloth or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot"							

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11. RELIABILITY

NO.	Item	Condition	Criterion
1	High Temperature Operating	70°ℂ, 240Hrs	
2	Low Temperature Operating	- 2 0°C, 240Hrs	
3	High Humidity	40℃, 90%RH, 96Hrs	
4	High Temperature Storage	80℃, 240Hrs	
5	Low Temperature Storage	-30℃, 240Hrs	No defect in cosmetic and operational
		Random wave	function allowable.
6	Vibration	10 ~ 100Hz	Total current Consumption should be below double of
		Acceleration: 2g	initial value.
		2 Hrs per direction(X,Y,Z)	
		-20℃ to 25℃ to 70℃	
7	Thermal Shock	(60Min) (5Min) (60Min)	
		10Cycles	
8	ESD Testing	Contract Discharge Voltage: +1 ~ 5kV and –1 ~ –5kV	There will be discharged ten times at every discharging
		Air Discharge Voltage: +1 ~ 8kV and –1 ~ -8kV	voltage gap is 1kV.

Note:

- 1) Above conditions are suitable for GOLDENTEK standard products.
- 2) For restrict products, the test conditions listed as above must be revised.

12. HANDLING PRECAUTIONS

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifloroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

 It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.

12. HANDLING PRECAUTIONS (Continued)

- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them.

However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance ,for years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol.

Which should be burned up later.

- When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. Outline Drawing VSS VDD POLARIZER: TRANSFLECTIVE/POSITIVE POWER SUPPLY: +5V,VLCD;4,5V STORAGE TEMP: -30°C-80°C OPERATING TEMP: -20°C-70°C VIEWING ANGLE: 6:00 CLOCK LCD TYPE: STN , YELLOW-GREEN 6 _CD DRIVER: KS0066 & JNMARKED TOLERANCE: 44.00±1.0 -20.0±0.3 -5.00 5,50-DRIVE MODE: 1/16 DUTY, 1 RS S 4 **R**/√ O PITCH 1.0X15=15.0 CONDUCTIVE: 0.70 TYP GAP: 0.30 TYP Φ 36,0MIN 53,0±0,3 -34.10· 43.Q DB0 DB1 ω DB2 DB3 9 * KS0065 ±0,2mm 10 10.0MJN DB4 \Box DB5 ს -1.60±0.1 -4.00MAX STIFFER DB6 1-8.00NAX 1 DB7 14 ⊳ 5 -9.50-1 16 STIFFER -1281 -2.15--15,00-

21/22

PRODUCT SPECIFICATIONS

REV:A

MODEL

LMC16213A-YTDSYW-B0

13. **BOM**

ITEM	DIMENSION	LONDA PART NO	Manufacturer Part No	Manufacturer	Remark
Metal Frame	43.0 x 20.0 x 8.0mm	LMC16213A-TK		Jingcheng	Black, Thickness: 0.5mm
LCD	41.8 x 18.8/14.8mm		GSE7049	Goldentek	STN ,Y-G ,TRANSFLECTIVE
Backlight	41.4 x 14.4 x 1.1mm		TJ015A-01	Tianwei	4.1V Yellow-Green
Heat Seal	41.0 x 2.7 x 2.0mm			Hengchang	P0.1, Hardness:40, STAN.
PCB	53.0 x 20.0 x 1.6mm	LMC16213D V1	.0	Chaohui	2 Layer, Gold-plating, FR4
Solder	Lead Free			RASING	

ltem	Location	Spec
Capacitor	C1	No
	C2	No
	C3	No
	C4	No
Jumper	J1	Short Circuit
	J2	Open
	J3	Open
	J4	Open
	J5	Open
	J6	Open
	J7	Open
	J8	Open
Transistor	Q1	No
	R1	2.2K NEC 0805
	R2	2.2K NEC 0805
	R3	2.2K NEC 0805
	R4	2.2K NEC 0805
Posistor	R5	2.2K NEC 0805
Resistor	R6	91K NEC 0805
	R8	No
	R8	No
	R9	510hm NEC 1206
	RT	No
IC	U1	KS0066
	U2	KS0065
	U3	No

The soldering Temperature is $270\pm5^{\circ}$ and Soldering Time should be less than 3 Sec,and soldering iron power should be less than 40W, and for solder connectors iron could be 80W.